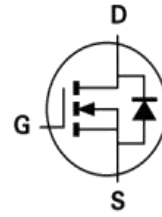


MAIN CHARACTERISTICS

I_D	160A
V_{DSS}	40V
$R_{DS(on)-typ}$ (@ $V_{GS}=10V$)	1.8m Ω



FEATURES

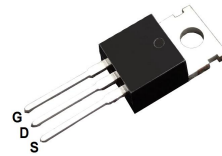
- Advanced Trench Technology
- Provide Excellent $R_{DS(ON)}$ and Low Gate Charge
- Lead free product is acquired

APPLICATIONS

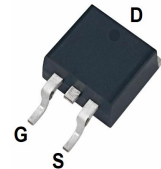
- Load Switch
- PWM Application
- Power management

MECHANICAL DATA

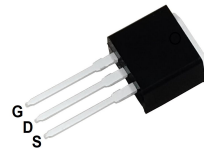
- Case: Molded plastic
- Mounting Position: Any
- Molded Plastic: UL Flammability Classification Rating 94V-0
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Solder bath temperature 275°C maximum, 10s per JESD 22-B106



TO-220C



TO-263C



TO-262C

Product specification classification

Part Number	Package	Mode Name	Pack
LT160N04AP	TO-220C	LT160N04AP	Tape
LT160N04AT	TO-263C	LT160N04AT	Tape
LT160N04AI	TO-262C	LT160N04AI	Tape

Maximum Ratings at Tc=25°C unless otherwise specified

Characteristics	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	V
Continue Drain Current	I_D	160	A
Pulsed Drain Current (Note1)	I_{DM}	640	A
Power Dissipation	P_D	120	W
Single Pulse Avalanche Energy (Note5)	E_{AS}	420	mJ
Operating Temperature Range	T_J	150	°C
Storage Temperature Range	T_{STG}	-55 to +150	°C
Thermal Resistance, Junction to Case(Note 2)	$R_{\theta JC}$	1.0	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	35	°C/W

Electrical Characteristics at Tc=25°C unless otherwise specified

Characteristics	Test Condition	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	BV_{DSS}	40	-	-	V
Drain-Source Leakage Current	$V_{DS} = 40\text{ V}, V_{GS} = 0\text{ V}$	I_{DSS}	-	-	1	μA
Gate Leakage Current	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$	I_{GSS}	-	-	± 100	nA
Gate-Source Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	$V_{GS(th)}$	1	-	2.5	V
Drain-Source On-State Resistance	$V_{GS} = 10\text{ V}, I_D = 30\text{ A}$	$R_{DS(on)}$	-	1.8	2.5	m Ω
	$V_{GS} = 4.5\text{ V}, I_D = 20\text{ A}$		-	2.3	2.7	m Ω
Input Capacitance	$V_{GS} = 0\text{ V}, V_{DS} = 20\text{ V}, f = 1\text{ MHz}$	C_{iss}	-	14500	-	pF
Output Capacitance		C_{oss}	-	845	-	pF
Reverse Transfer Capacitance		C_{rss}	-	210	-	pF
Turn-on Delay Time	$V_{DS}=20\text{ V}, I_D=30\text{ A}$ $V_{GS}=10\text{ V}, R_G=3\text{ }\Omega$	$t_{d(ON)}$	-	13	-	ns
Rise Time		t_r	-	9	-	ns
Turn-Off Delay Time		$t_{d(OFF)}$	-	100	-	ns
Fall Time		t_f	-	15	-	ns
Total Gate Charge	$V_{DS}=20\text{ V}, I_D=30\text{ A}, V_{GS}=10\text{ V}$	Q_G	-	95	-	nC
Gate to Source Charge		Q_{GS}	-	15	-	nC
Gate to Drain Charge		Q_{GD}	-	19	-	nC

Source-Drain Diode Characteristics at Ta=25°C unless otherwise specified

Characteristics	Test Condition	Symbo	Min.	Typ.	Max.	Unit
Maximun Body-Diode Continuous Current (Note 2)		I_S	-	-	160	A
Maximun Body-Diode Pulsed Current		I_{SM}	-	-	640	A
Drain-Source Diode Forward Voltage (Note 3)	$I_{SD} = 30\text{ A}$	V_{SD}	-	-	1.2	V
Reverse Recovery Time	$I_S = I_F, I_{SD}=30\text{ A}, V_{GS} = 0\text{ V},$	t_{rr}	-	35	-	ns
Reverse Recovery Charge	$di/dt = 100\text{ A}/\mu\text{s}$ (Note3)	Q_{rr}	-	24	-	μC

Note2:Pulse test: 300 μs pulse width, 2 % duty cycle

RATINGS AND CHARACTERISTIC CURVES

Figure1: Output Characteristics

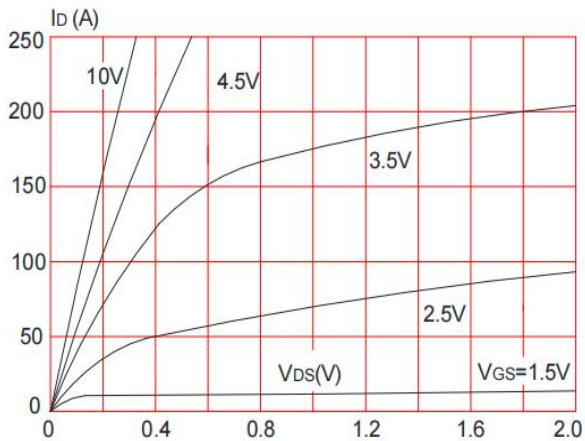


Figure 2: Typical Transfer Characteristics

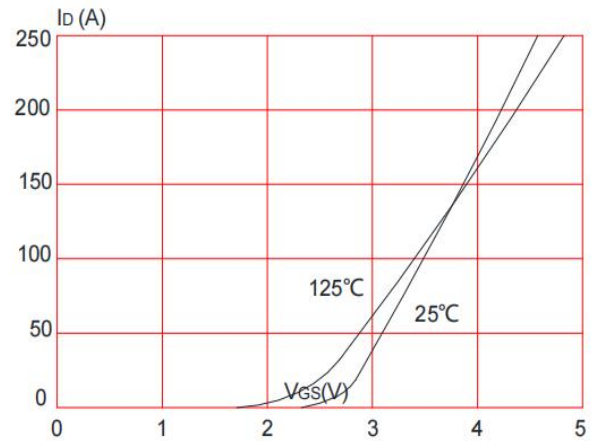


Figure 3: On-resistance vs. Drain Current

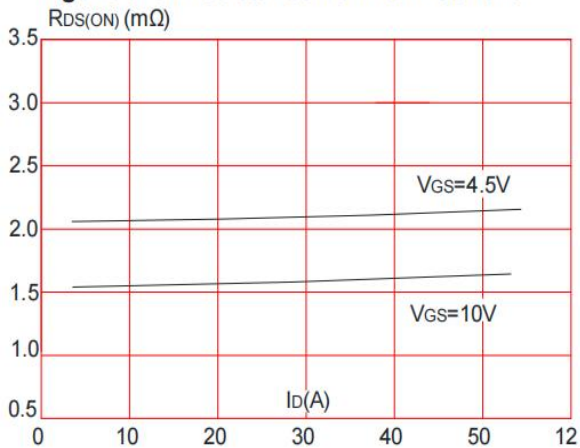


Figure 4: Body Diode Characteristics

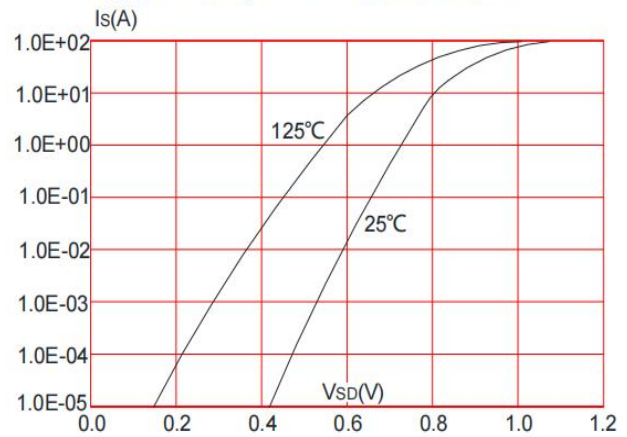


Figure 5: Gate Charge Characteristics

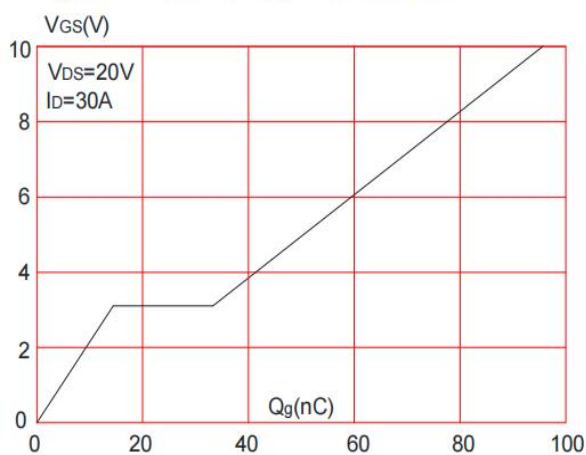
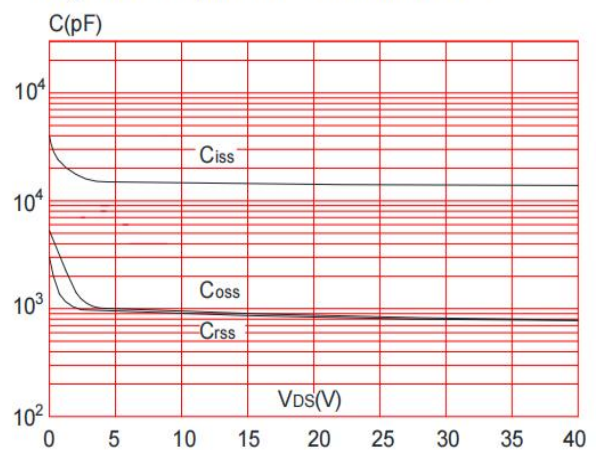


Figure 6: Capacitance Characteristics



RATINGS AND CHARACTERISTIC CURVES

Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

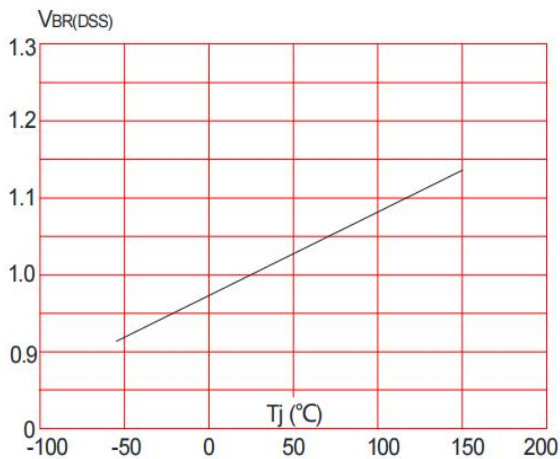


Figure 8: Normalized on Resistance vs. Junction Temperature

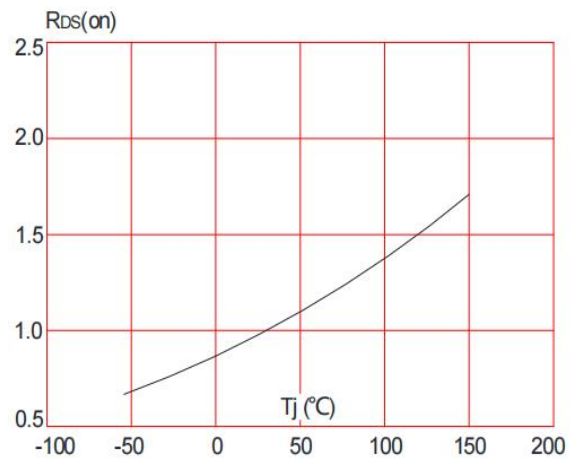


Figure 9: Maximum Safe Operating Area

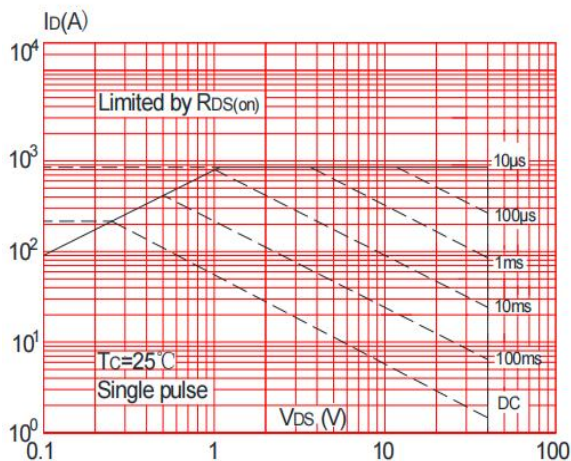


Figure 10: Maximum Continuous Drain Current vs. Case Temperature

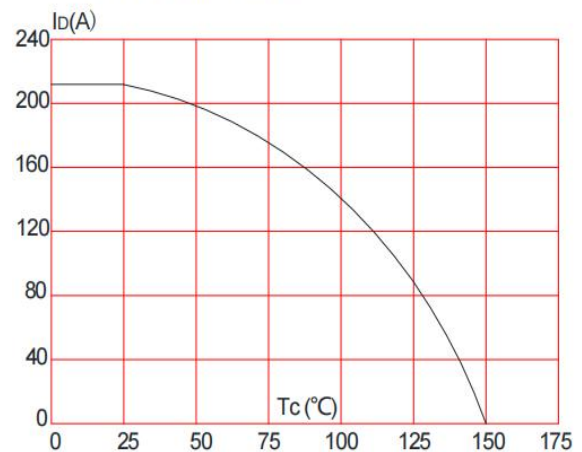
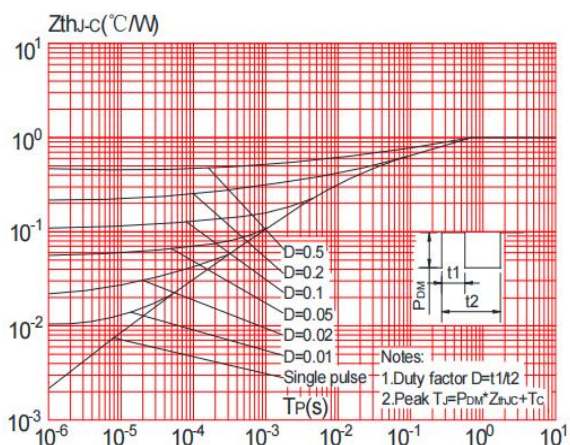
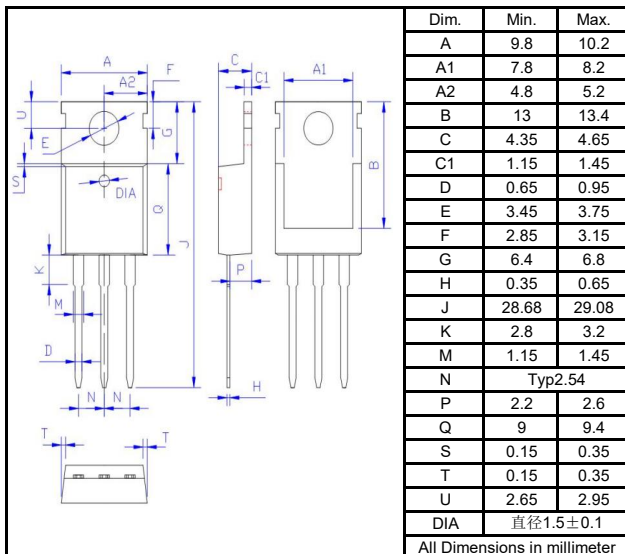


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

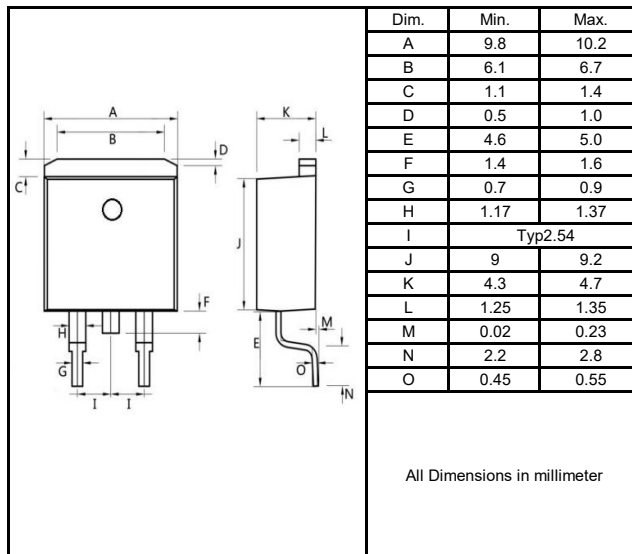


Package Outline Dimensions millimeters

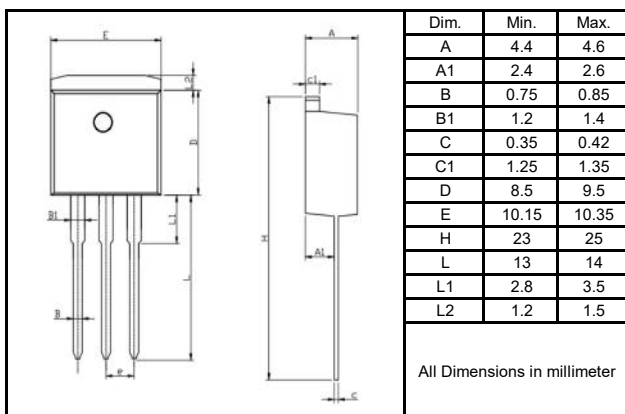
T0-220C



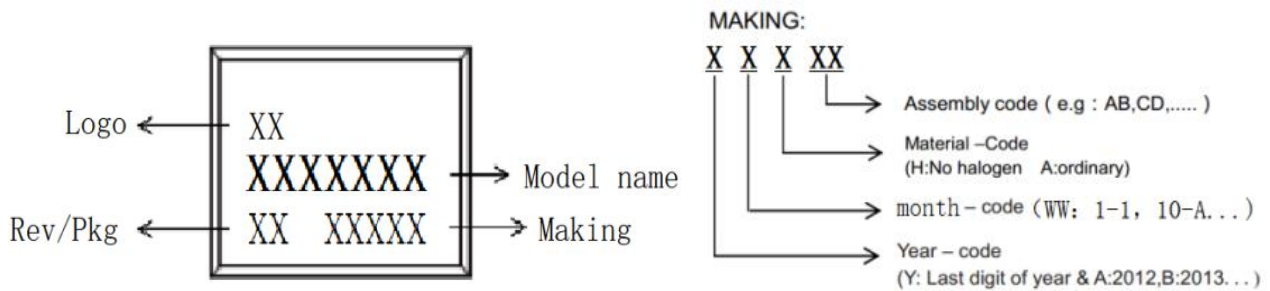
T0-263C



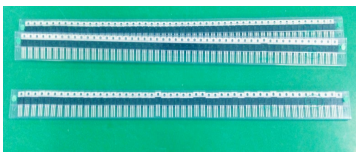
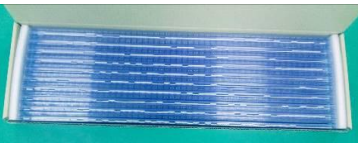
T0-262C



Marking on the body



packing instruction

PKG	最小包装	内盒	外箱
TO-220C TO-263C TO-262C			
	50PCS/管	1000pcs/盒	5000pcs/箱
TO-263C			
	800pcs/盘	1600pcs/盒	8000pcs/箱

Notice

All product, product specifications and data are subject to change without notice to improve. The right to explain is owned by LINGXUN electronics company.

Confirm that operation temperature is within the specified range described in the product specification. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

LINGXUN electronics shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.